

Notice of References Cited

Application/Control No.

10/071,870

Applicant(s)/Patent Under
Reexamination
SAGUES ET AL.

Examiner

Gopal C. Ray

Art Unit

2111

Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-5,872,999	02-1999	Koizumi et al.	710/72
	B	US-5,630,170	05-1997	Koizumi et al.	710/12
	C	US-5,701,515	12-1997	Gradeler, Eric J.	710/14
	D	US-6,301,633	10-2001	Chapman, John T.	710/305
	E	US-6,349,235	02-2002	Gibart et al.	700/11
	F	US-4,360,913	11-1982	Struger et al.	370/535
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	"High-density and high-pin count flexible SMD connector for high-speed data bus" by Sasaki, S; Kishimoto, T. (abstract only)
	V	"High performance mainframe computer cables" by Beaman, B. (abstract only)
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.